



Material Content Data Sheet



Sales Product Name		SAF-XE164K-96F66L AC		Issued		20. July 2018		
MA#		MA001584946						
Package		PG-LQFP-100-3		Weight*		752.64 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	40.856	5.43	5.43	54283	54283
leadframe	inorganic material	phosphorus	7723-14-0	0.068	0.01		90	
	non noble metal	zinc	7440-66-6	0.272	0.04		361	
	non noble metal	iron	7439-89-6	5.439	0.72		7227	
wire	non noble metal	copper	7440-50-8	220.854	29.34	30.11	293439	301117
	noble metal	gold	7440-57-5	4.244	0.56	0.56	5638	5638
encapsulation	organic material	carbon black	1333-86-4	2.299	0.31		3055	
	plastics	epoxy resin	-	62.081	8.25		82484	
	inorganic material	silicondioxide	60676-86-0	395.476	52.55	61.11	525452	610991
leadfinish	non noble metal	tin	7440-31-5	8.316	1.10	1.10	11050	11050
plating	noble metal	silver	7440-22-4	2.259	0.30	0.30	3001	3001
glue	plastics	epoxy resin	-	2.619	0.35		3480	
	noble metal	silver	7440-22-4	7.858	1.04	1.39	10440	13920
*deviation	< 10%				Sum in total:	100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption

Company	Infineon Technologies AG
Address	81726 München
Internet	www.infineon.com